

High-Voltage Low-Noise Inductorless EL Lamp Driver

Features

- No External Components required when using an External Electroluminescent (EL) Clock Frequency
- EL Frequency can be set by an External Resistor
- · Low Noise
- · DC to AC Converter
- Drives up to 5 nF Load (Approximately 1.5 in² Lamp)
- · Output Voltage Regulation
- · Enable Function
- EL Lamp Dimming

Applications

- · Cellphone Keypads and Displays
- Transceivers
- MP3 Plavers
- Watches
- · Pagers
- · Measuring Instruments/Gauge

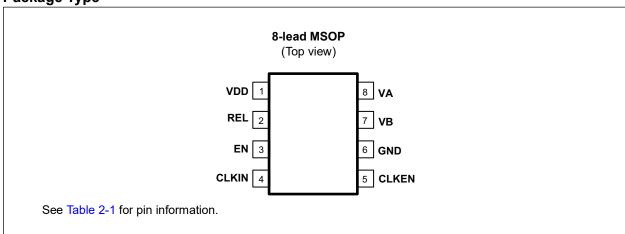
General Description

The HV850 is a high-voltage EL Lamp Driver IC. It is designed to drive EL lamps of up to 1.5 in² with capacitive values of up to 5 nF. The HV850 converts a low-voltage DC input to a high-voltage AC output across an EL lamp. It uses a charge pump scheme to boost the input voltage, eliminating the need for external inductors, diodes, and high-voltage capacitors, components commonly found in conventional topologies.

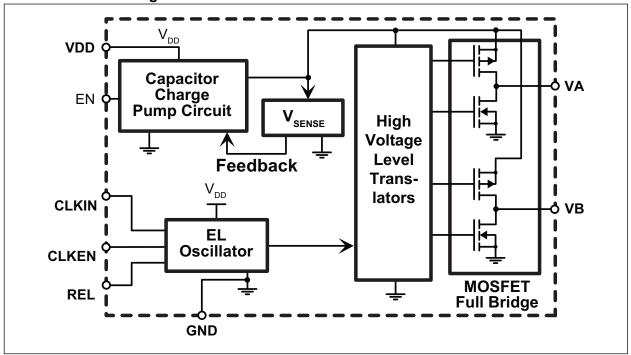
The charge pump circuit discharges its energy into an EL lamp through a high-voltage H-bridge. Once the voltage reaches its regulated limit, it is turned off to conserve power. The EL lamp is then discharged to ground and the H-bridge changes state to allow the charge pump to charge the EL lamp in the opposite direction.

The EL lamp frequency can be set either by an external resistor, R_{EL} , or by applying an external clock where the clock frequency is divided by 128 to set the EL lamp frequency.

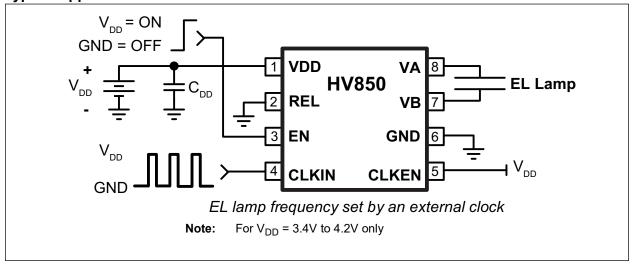
Package Type



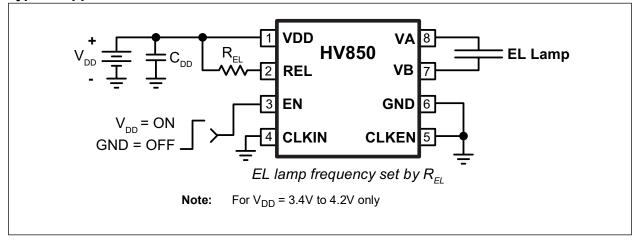
Functional Block Diagram



Typical Application Circuit 1



Typical Application Circuit 2



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings(†)

Supply Voltage, V _{DD}	
Operating Ambient Temperature Range, T _A	
Storage Temperature Range, T _S	
Power Dissipation:	
8-lead MSOP	

RECOMMENDED OPERATING CONDITIONS

Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions
Input Voltage	V _{DD}	3	_	4.2	V	
EL Lamp Frequency	f _{EL}	50	_	500	Hz	
EL Lamp Capacitance	C _{LOAD}	0	_	5	nF	
Operating Ambient Temperature	T _A	-25	_	+85	°C	

ELECTRICAL CHARACTERISTICS

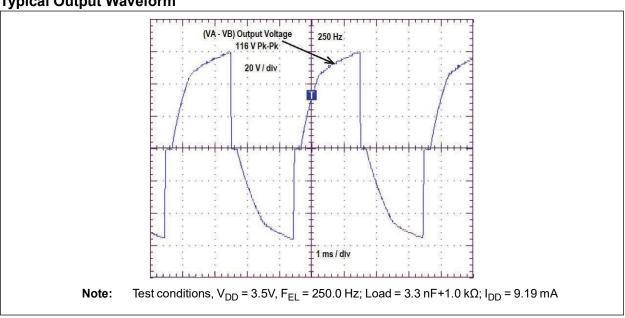
Electrical Specifications: V _{DD} = 3.5V and T _A = 25°C unless otherwise specified.									
Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions			
Quiescent Current	I _{DDQ}	_	_	150	nA	EN = 0V			
Peak Output Voltage	V _A or V _B	63	70	77	V	No load			
Peak-to-Peak Output Voltage	V _A –V _B	126	140	154	V	No load			
EL Lamp Frequency	f _{EL}	225	250	275	Hz	REL = 1.65 M Ω or CLK = 32 kHz			
Operating Current	I _{DD}	_	_	16	mA	V _{DD} = 3.5V,			
Peak Output Voltage	V _A or V _B	54	_	74	V	$R_{EL} = 1.5 M\Omega,$			
Peak-to-Peak Output Voltage	V _A –V _B	108	_	148	V	Load = $3.3 \text{ nF} + 1 \text{ k}\Omega$			
EL Lamp Frequency	f _{EL}	250	294	338	Hz	(See Figure 3-1.)			
Output Voltage Rise Time	t _{rout}	1.5	_	_	ms	f _{EL} = 250 Hz, 1 in ² lamp, 10% to 90% of final value			
LOGIC INPUTS									
Input Logic Low Voltage	V _{IL}	0	_	0.5	V				
Input Logic High Voltage	V _{IH}	2	_	V_{DD}	V				
Input Logic Low Current	I _{IL}	_	_	1	μA				
Input Logic High Current	I _{IH}	_	_	1	μA				
Enable Input Rise Time (For Delay Turn-on)	EN _{rise}	0.01	_	10	ms	Using external R-C circuit			
Enable Input Fall Time (For Delay Turn-off)	EN _{fall}	10µ	_	5	s	(See Figure 3-2.)			
Logic Input Capacitance	C _{IN}	_	_	10	pF				

[†] **Notice:** Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

TEMPERATURE SPECIFICATIONS

Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions
TEMPERATURE RANGE						
Storage Temperature	T _S	-65	_	+150	°C	
Operating Ambient Temperature	T _A	-25	_	+85	°C	
PACKAGE THERMAL RESISTANCE						
8-lead MSOP	θ_{JA}	_	216	_	°C/W	

Typical Output Waveform



2.0 PIN DESCRIPTION

The details on the pins of HV850 are listed in Table 2-1. Refer to **Package Type** for the location of pins.

TABLE 2-1: PIN FUNCTION TABLE

Pin Number	Pin Name	Description
1	VDD	Input supply voltage pin
2	REL	An external resistor to VDD will set the EL lamp frequency. The EL lamp frequency is inversely proportional to the resistor value.
3	EN	Enable input pin. Logic high will turn on the device. An external R-C circuit can be added for a delayed turn-off. Logic low will turn off the device only for V_{DD} = 3.4V to 4.2V. For V_{DD} lower than 3.4V, logic low will not turn off the device.
4	CLKIN	Logic input pin. An external logic clock applied to this pin can be used to set the EL lamp frequency. (See Figure 3-3.) This is useful for applications requiring the EL lamp to be synchronized to a system clock. Connect to ground when not in use.
5	CLKEN	Logic input pin. Logic high will cause the EL lamp frequency to be set by the CLKIN input. Logic low will cause the EL lamp frequency to be set by the external R _{EL} resistor.
6	GND	IC ground pin
7	VB	EL lamp driver output pin. The EL lamp is connected across VA and VB terminals.
8	VA	EL lamp driver output pin. The EL lamp is connected across VA and VB terminals.

3.0 APPLICATION INFORMATION

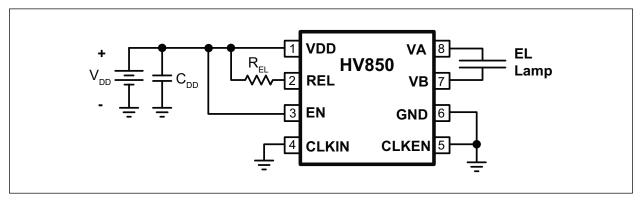


FIGURE 3-1: Typical Application Circuit (without Enable Function).

TABLE 3-1: TYPICAL PARAMETERS

Load (Lamp Equivalent)	R _{EL} (MΩ)	V _{DD} (V)	I _{DD} (mA)	Peak V _A (V)	f _{EL} (Hz)
		3	8.9	53	
3.3 nF + 1 kΩ	1.5	3.5	10.2	61	294
		4	10.4	66	

Note 1: $C_{DD} = 2.2 \mu F, 6.3 \text{V low ESR}$

TABLE 3-2: TYPICAL PERFORMANCE

Lamp Size	R _{EL} (MΩ)	V _{DD} (V)	I _{DD} (mA)	Peak V _A (V)	f _{EL} (Hz)	Brightness (cd/m²)
		3	8.4	53		7.31
1	1.65	3.5	9.4	62	250	10.35
		4	9.9	66	1	12.62
		3	5.5	62		11.54
0.5	2	3.5	5.3	68	210	14.33
		4	4.9	68	1	14.9
		3	5.6	62		8.55
1	3.3	3.5	5.4	67	128	10.29
		4	5	68	1	10.94
		3	4.6	64		8.25
0.5	3.3	3.5	4.1	68	128	9.62
		4	3.8	68	1	9.95
		3	4.8	64		6.02
1	4.7	3.5	4.4	68	89	7.5
		4	5	68		10.94

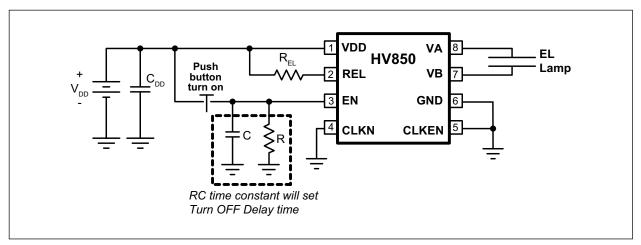


FIGURE 3-2: Push Button Turn-on with Delay Turn-off (For $V_{DD} = 3.4V$ to 4.2V only).

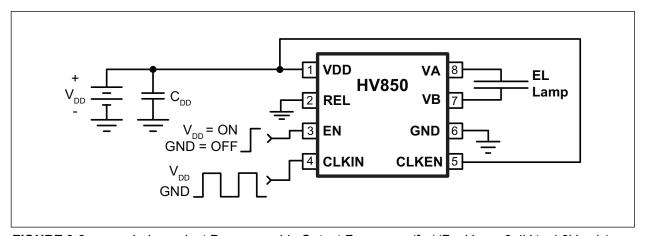


FIGURE 3-3: Independent Programmable Output Frequency (f_{EL}) (For $V_{DD} = 3.4V$ to 4.2V only).

3.1 EL Lamp Dimming Using PWM

EL lamp dimming can be achieved by applying a PWM signal to the Enable pin. The PWM signal duty cycle is proportional to the lamp brightness. This is done by

pulse skipping the output pulses. The PWM frequency should be kept below the EL frequency but above 50 Hz to avoid flickering.

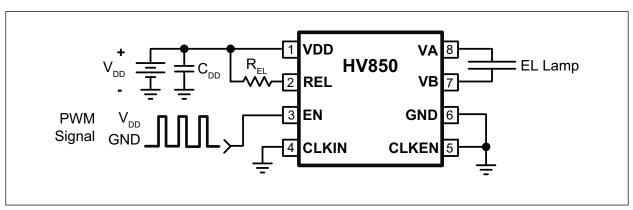
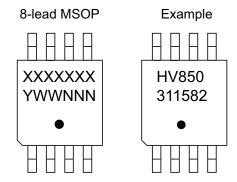


FIGURE 3-4: PWM Dimming Circuit (For $V_{DD} = 3.4V$ to 4.2V only).

4.0 PACKAGING INFORMATION

4.1 **Package Marking Information**



Legend: XX...X Product Code or Customer-specific information

> Υ Year code (last digit of calendar year) ΥY Year code (last 2 digits of calendar year) WW Week code (week of January 1 is week '01')

Alphanumeric traceability code NNN

Pb-free JEDEC® designator for Matte Tin (Sn) (e3)

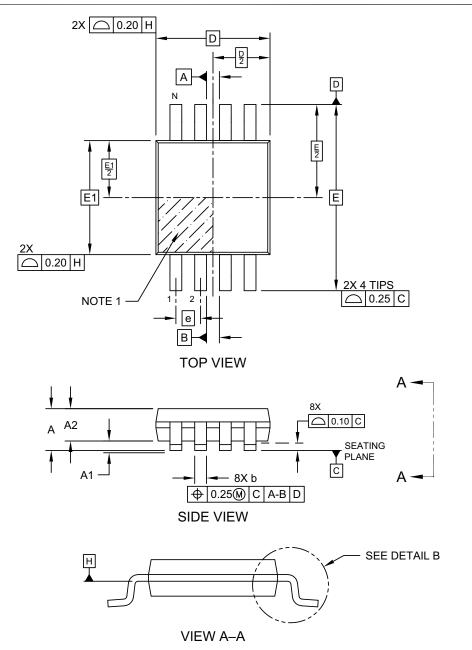
This package is Pb-free. The Pb-free JEDEC designator (@3)

can be found on the outer packaging for this package.

In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for product code or customer-specific information. Package may or not include the corporate logo.

8-Lead Plastic Micro Small Outline Package (A3X) - 3x3 mm Body [MSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

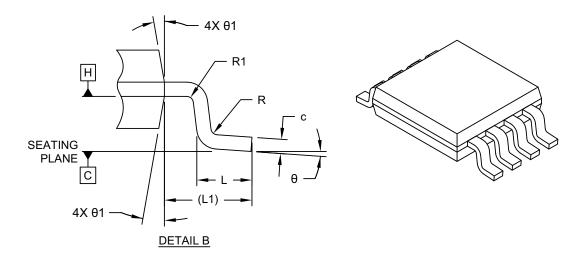


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Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	MILLIMETERS					
	Dimension Limits	MIN	NOM	MAX		
Number of Terminals	N		8			
Pitch	е		0.65 BSC			
Overall Height	А	-	_	1.10		
Standoff	A1	0.00	_	0.15		
Molded Package Thickness	A2	0.75	0.85	0.95		
Overall Length	D	3.00 BSC				
Overall Width	E	4.90 BSC				
Molded Package Width	E1	3.00 BSC				
Terminal Width	b	0.22	_	0.40		
Terminal Thickness	С	0.08	_	0.23		
Terminal Length	L	0.40	0.60	0.80		
Footprint	L1	0.95 REF				
Lead Bend Radius	R	0.07 – –				
Lead Bend Radius	R1	0.07 – –				
Foot Angle	θ	0°	_	8°		
Mold Draft Angle	θ1	5°	_	15°		

Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
 Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm per side.

Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

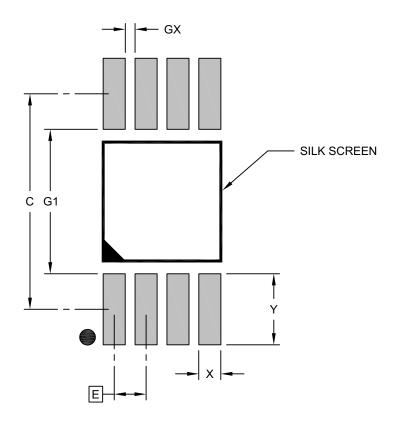
REF: Reference Dimension, usually without tolerance, for information purposes only.

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8-Lead Plastic Micro Small Outline Package (A3X) - 3x3 mm Body [MSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	MILLIMETERS				
Dimension	Dimension Limits			MAX	
Contact Pitch	0.65 BSC				
Contact Pad Spacing	С		4.40		
Contact Pad Width (X8) X				0.45	
Contact Pad Length (X8)	Υ			1.45	
Contact Pad to Contact Pad (X4)	G1	2.95			
Contact Pad to Contact Pad (X6)	0.20				

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-2111-A3X Rev F

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APPENDIX A: REVISION HISTORY

Revision A (September 2023)

- Converted Supertex Doc# DSFP-HV850 to Microchip DS20005904A
- Changed the package marking format
- · Updated the package outline drawing
- Made minor text changes throughout the document

PRODUCT IDENTIFICATION SYSTEM

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PART NO.	<u> </u>		- <u>х</u> - <u>х</u>	Ex	ample:	
Device	Package Options		Environmental Media Type	a)	HV850MG-G:	High-Voltage Low-Noise Inductor- less EL Lamp Driver, 2500/Reel
Device:	HV850	=	High-Voltage Low-Noise Inductorless EL Lamp Driver			
Package:	MG	=	8-lead MSOP			
Environmental:	G	=	Lead (Pb)-free/RoHS-compliant Package			
Media Type:	(blank)	=	2500/Reel for an MG Package			

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